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ECMF02-4CMX8

Datasheet - production data

Common mode filter with ESD protection for USB 2.0 interface

Micro QFN-8 L (pin view)

Features

- Integrated common mode filter
- Differential pair ESD protection
- 16 V V_{BUS} ESD and EOS protection
- ID pin ESD protection
- Low profile micro QFN-8L package
- High bandwidth: > 6 GHz
- Optimized for high speed USB 2.0
- High common mode attenuation at 900 MHz and 1.8 GHz
- Support for audio over USB 2.0 thanks to bidirectional ESD protection
- Ultra compact, low board space
- Low height: < 0.55 mm

Complies with the following standards:

- IEC 61000-4-2 level 4:
 - ±15 kV (air discharge)
 - ±8 kV (contact discharge)
- RoHS2 compliant

Applications

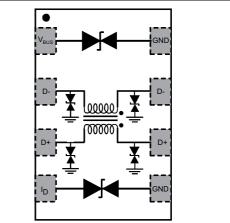
Where transient overvoltage protection in ESD sensitive equipment is required, such as:

- Computers
- Printers
- Communication systems
- Cellular phone handsets and accessories
- Video equipment

Description

The ECMF02-4CMX8 affords key component integration such as common mode filter D+ and D- lines and ESD protection on all lines. This device offers an optimized flow-through footprint for USB 2.0 applications.

Figure 1. Pin configuration (top view)



This is information on a product in full production.

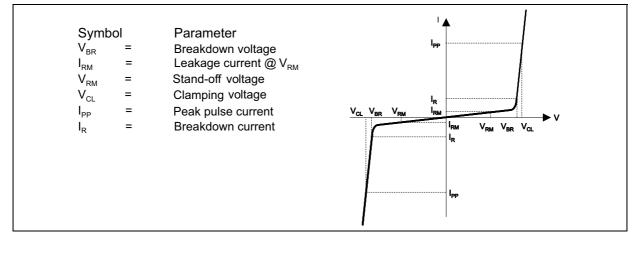
1 Characteristics

Symbol		Value	Unit		
V _{PP}	Peak pulse voltage ⁽¹⁾ ESD discharge IEC 61000-4-2, level 4 Contact discharge on D+/D- pins Contact discharge on V _{BUS} and I _D pins Air discharge on all pins		10 20 30	kV	
P _{PP}	Peak pulse power (8/20µs) on V _{BUS}		150	W	
I _{PP}	Peak pulse current (8/20µs) on V _{BUS}		4.8	А	
Тj	Maximum operating junct	-40 to +125	°C		
T _{stg}	Storage temperature rang	-55 to +150	°C		

Table 1. Absolute maximum ratings (T _{amb} = 25 °C)
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1. Measurements done on IEC 61000-4-2 test bench. For further details see Application note AN3353.

Figure 2. Electrical characteristics - definitions





Symbol	Test conditions	Min.	Тур.	Max.	Unit		
	Data lines						
V_{BR}	I _R = 1 mA 6				V		
I _{RM}	V _{RM} = 5.5 V per line			100	nA		
R _{DC}	DC serial resistance on data line		3	4	Ω		
	V _{BUS}						
V_{BR}	I _R = 1 mA	15	16.5	18	V		
I _{RM}	V _{RM} = 12 V			50	nA		
V _{CL}	Clamping voltage. $I_{PP} = 1 \text{ A}, t_p = 8/20 \mu\text{s}$			20	V		
V _{CL}	Clamping voltage. $I_{PP} = 2.5 \text{ A}, t_p = 8/20 \mu\text{s}$			24	V		
	۱ _D						
V_{BR}	I _R = 1 mA	6			V		
I _{RM}	V _{RM} = 1.5 V per line			100	nA		

Table 2. Electrical characteristics (values, T_{amb} = 25 °C)



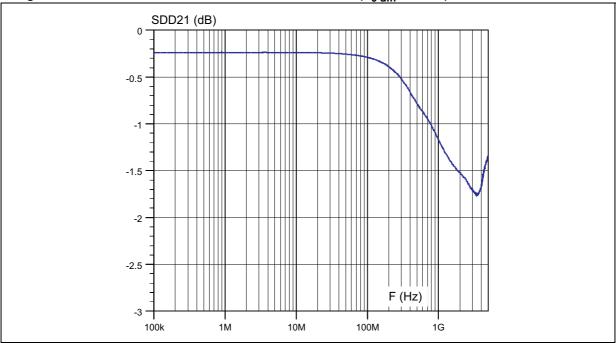
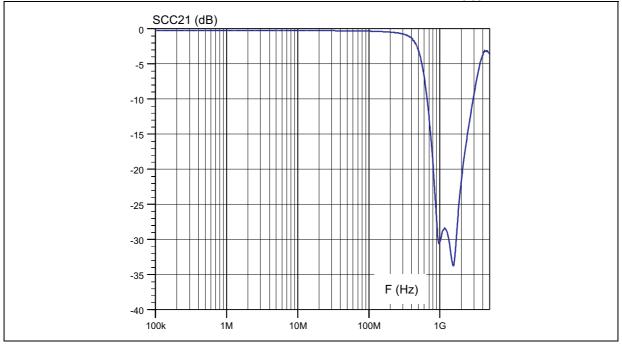


Figure 3. SDD21 differential attenuation measurement (Z $_{\rm 0 \; diff}$ = 90 Ω) for data lines D+ and D-







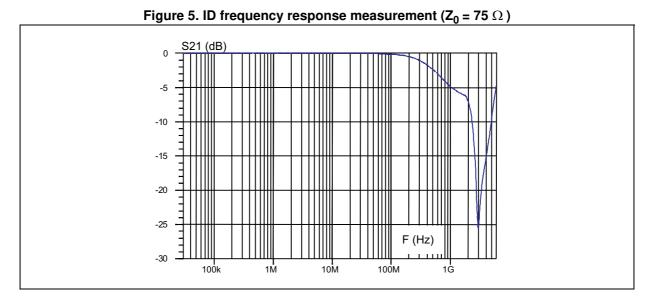
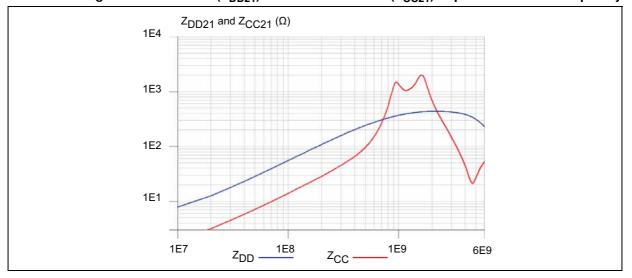


Figure 6. Differential (Z_{DD21}) and common mode (Z_{CC21}) impedance versus frequency





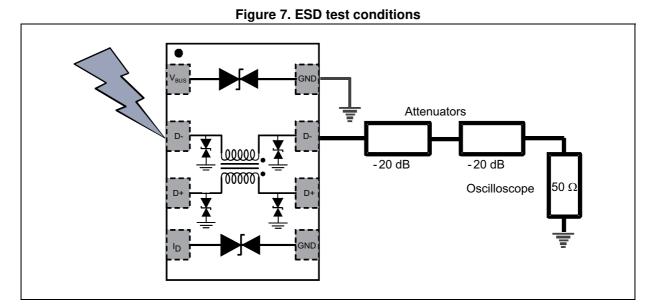
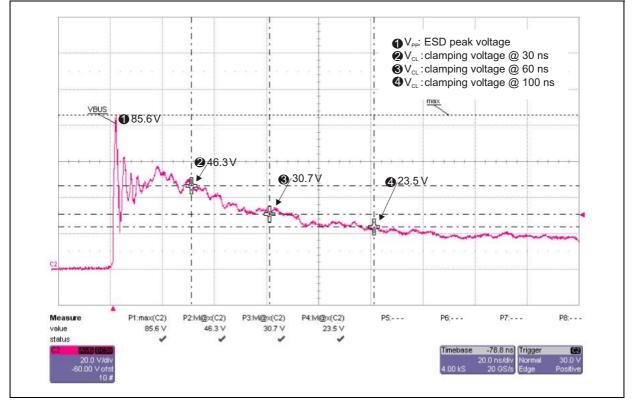


Figure 8. ESD response to IEC 61000-4-2 (+8 kV contact discharge) on V_{BUS}





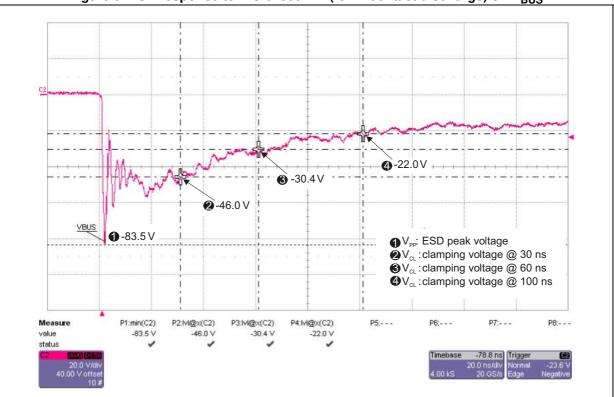
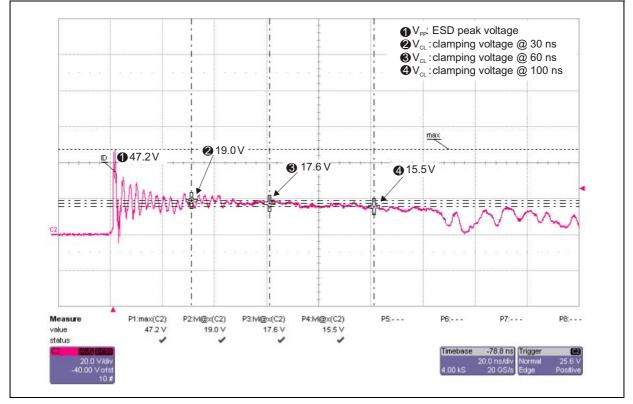


Figure 9. ESD response to IEC 61000-4-2 (-8 kV contact discharge) on V_{BUS}

Figure 10. ESD response to IEC 61000-4-2 (+8 kV contact discharge) on ID





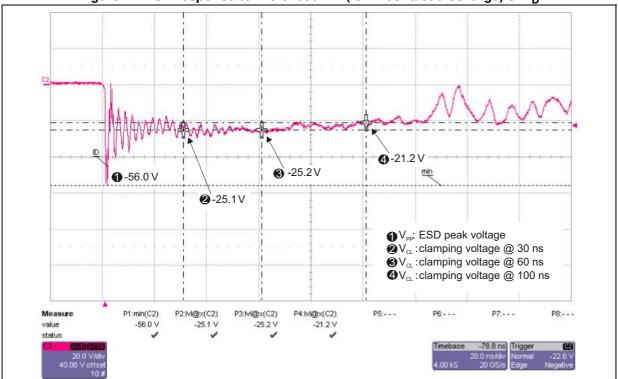
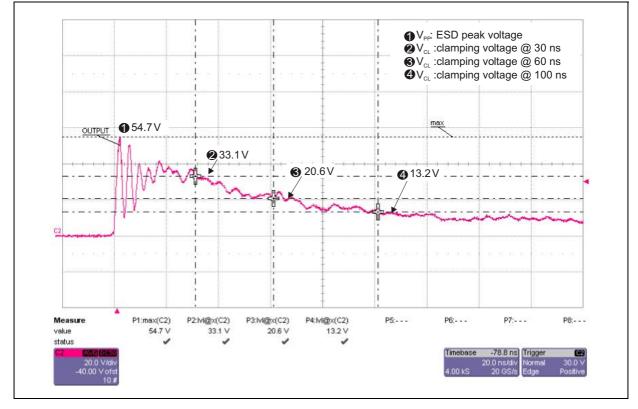


Figure 11. ESD response to IEC 61000-4-2 (-8 kV contact discharge) on ID

Figure 12. ESD response to IEC 61000-4-2 (+8 kV contact discharge) on differential lane





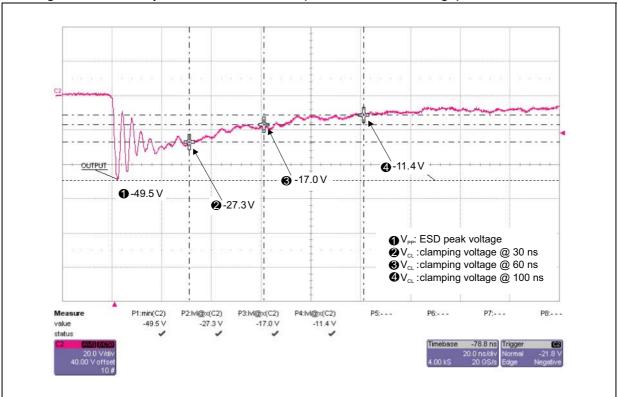
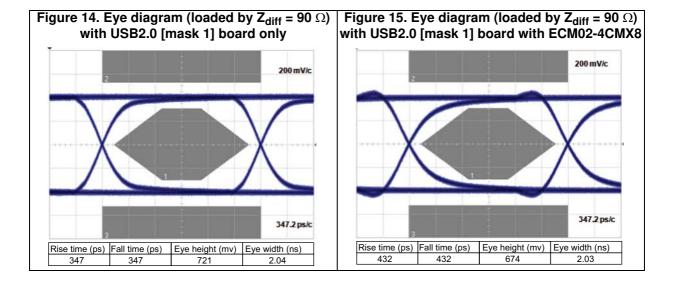


Figure 13. ESD response to IEC 61000-4-2 (-8 kV contact discharge) on differential lane





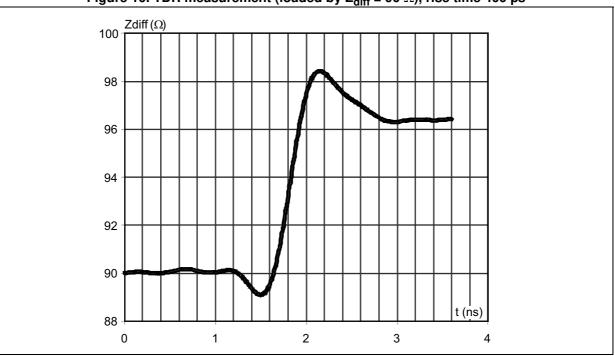
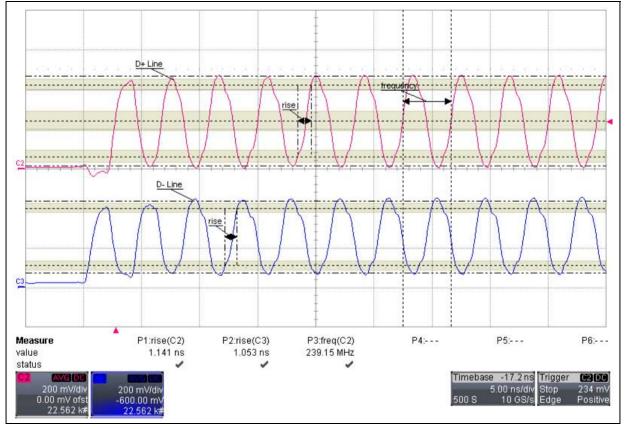


Figure 16. TDR measurement (loaded by \mathbf{Z}_{diff} = 90 Ω), rise time 400 ps

Figure 17. HS sync





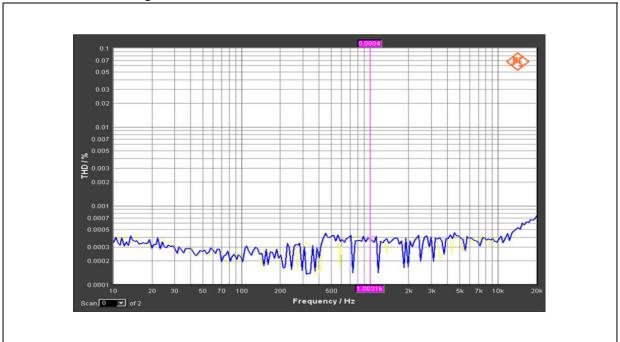
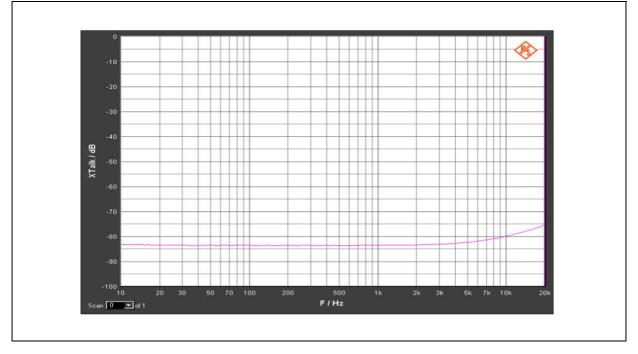


Figure 18. Total harmonic distortion on differential lanes

Figure 19. Crosstalk on differential lanes





2 **Application schematic**

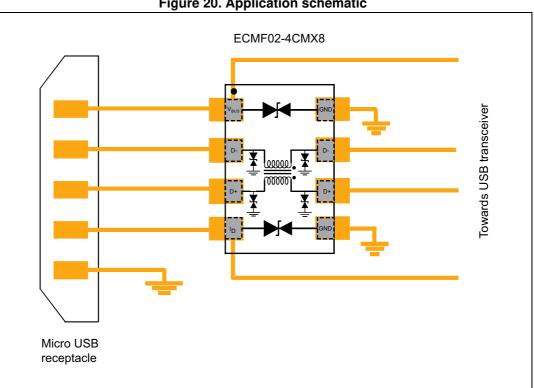


Figure 20. Application schematic



3 Package information

- Epoxy meets UL94, V0
- Lead-free packages

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com.* ECOPACK[®] is an ST trademark.

3.1 Micro QFN-8L package information

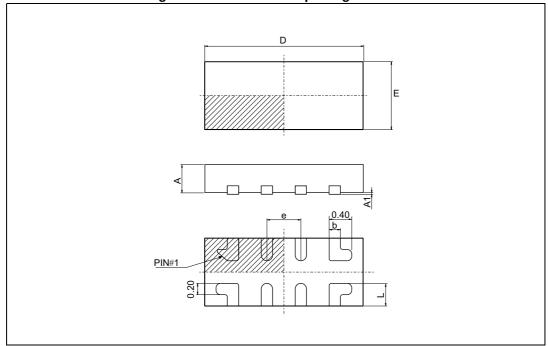


Figure 21. Micro QFN-8L package outline

Table 3. Micro QFN-8L package mechanical data

	Dimensions						
Ref.		Millimeters		Inches ⁽¹⁾			
	Тур.	Min.	Max.	Тур.	Min.	Max.	
A	0.50	0.45	0.55	0.020	0.018	0.022	
A1	0.02	0.00	0.05	0.0008	0.00	0.002	
b	0.20	0.15	0.25	0.008	0.006	0.010	
D	2.50	2.45	2.55	0.098	0.096	0.100	
E	1.20	1.15	1.25	0.047	0.045	0.049	



	Dimensions						
Ref.	Millimeters			Inches ⁽¹⁾			
	Тур.	Min.	Max.	Тур.	Min.	Max.	
е	0.50	0.45	0.55	0.020	0.018	0.022	
L	0.40	0.30	0.50	0.016	0.012	0.020	

Table 3. Micro QFN-8L package mechanical data (continued)

1. Values in inches are converted from mm and rounded to 4 decimal digits.

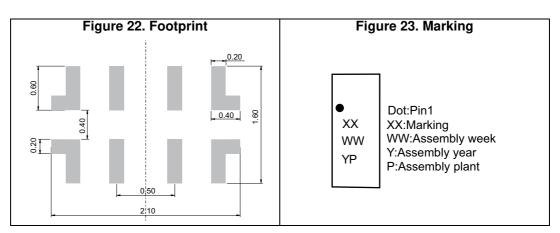
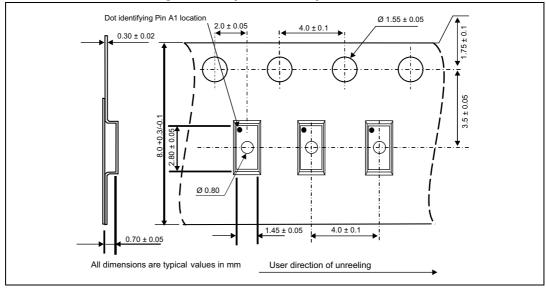
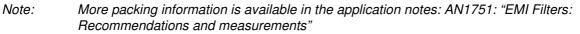


Figure 24. Tape and reel specifications







4 Ordering information

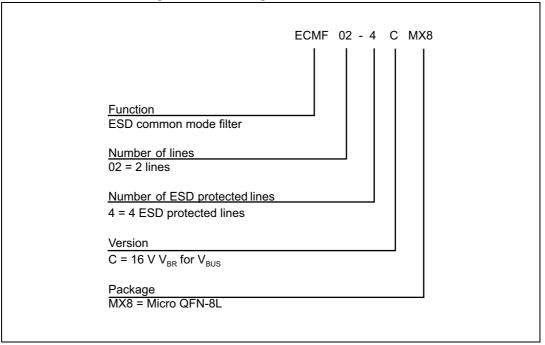


Figure 25. Ordering information scheme

Table 4. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
ECMF02-4CMX8	KG	Micro QFN-8L	3.7 mg	3000	Tape and reel

For the latest information on available order codes see the product pages on: www.st.com.

5 Revision history

Table 5. Document revision history

Date	Revision	Changes
19-Sep-2012	1	Initial release.
27-May-2014	2	Updated Figure 24, Figure 25 and reformatted the document.
05-May-2015	3	Added <i>Figure 6</i> . Updated <i>Table 1</i> . Format updated to current standard.



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